

Wavelength: 808 (\pm nm)
 Power: 200 (mw)
 Working temperature: $T_c=25^\circ\text{C}$
 Working current: $280\downarrow$ (mA)
 Threshold current: 100 (mA)
 Monitoring current: (mA)
 Working voltage: $2.1\downarrow$ (V)
 Working temperature: $-10\sim 40^\circ\text{C}$
 Storage temperature: $-40\sim 80^\circ\text{C}$
 Divergence angle: $15^{\circ}\times 30^{\circ}$

Package form: To-18 ($\varnothing 5.6\text{mm}$) single horizontal mold with glass window automatic package

Working medium: semiconductor laser

Wavelength: **808nm**

Light Output: **300mW CW**

Package Type: **TO-18($\varnothing 5.6\text{mm}$)**

■Absolute Maximum Ratings ($T_c=25^\circ\text{C}$)

Parameter	Symbol	Rating	Unit
Optical Output	P_o	300	mW
Reverse Voltage	V_r	2	V
Operating Temperature	T_{op}	$-10\sim +40$	$^\circ\text{C}$
Storage Temperature	T_{stg}	$-15\sim +85$	$^\circ\text{C}$

■Electrical and optical Characteristics($T_c=25^\circ\text{C}$)

Parameter	Symbols	Typ	Units
Threshold Current	I_{th}	110	mA
Operating Current	I_{op}	390	mA
Operating Voltage	V_{op}	1.8	Volts
Slope Efficiency	η	0.7	mW/mA
Beam Divergence (FWHM)	Parallel	$\theta \parallel$	10 deg
	Perpendicular	$\theta \perp$	32 deg
Lasing Wavelength	λ_p	808	nm